2SD2620J

Silicon NPN epitaxial planer type

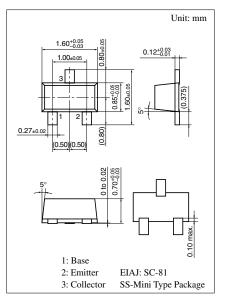
For low-frequency amplification

Features

- High forward current transfer ratio h_{FE}
- Low collector to emitter saturation voltage $V_{CE(sat)}$
- \bullet High emitter to base voltage V_{BEO}
- SS-mini type package

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	100	V
Collector to emitter voltage	V _{CEO}	100	V
Emitter to base voltage	V _{EBO}	15	V
Peak collector current	I _{CP}	50	mA
Collector current	I _C	20	mA
Collector power dissipation	P _C	125	mW
Junction temperature	Tj	125	°C
Storage temperature	T _{stg}	-55 to +125	°C



Marking Symbol: 3B

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 60 \text{ V}, I_E = 0$			0.1	μΑ
	I _{CEO}	$V_{CE} = 60 \text{ V}, I_B = 0$			1.0	μΑ
Collector to base voltage	V _{CBO}	$I_{\rm C} = 10 \ \mu A, \ I_{\rm E} = 0$	100			V
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$	100			V
Emitter to base voltage	V _{EBO}	$I_E = 10 \ \mu A, \ I_C = 0$	15			V
Forward current transfer ratio	h _{FE}	$V_{CE} = 10 \text{ V}, \text{ I}_{C} = 2 \text{ mA}$	400		1 200	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 1 \text{ mA}$		0.05	0.2	V
Transition frequency	f_{T}	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Noise voltage	NV	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}, \text{GB} = 80 \text{ dB}$		80		mV
		$R_g = 100 \text{ k}\Omega$, Function = FLAT				

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